

SN54ABT16825, SN74ABT16825 18-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS218D – JUNE 1992 – REVISED OCTOBER 2000

- Members of Texas Instruments' Widebus™ Family
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD 17
- Typical V_{OLP} (Output Ground Bounce) <1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs ($-32\text{-mA } I_{OH}$, $64\text{-mA } I_{OL}$)

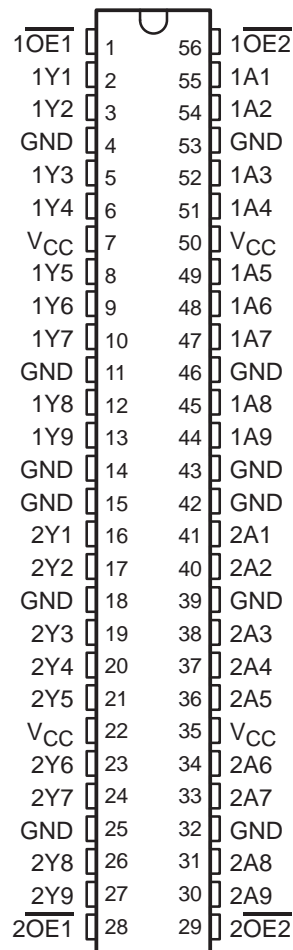
description

The 'ABT16825 devices are 18-bit buffers and line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. These devices can be used as two 9-bit buffers or one 18-bit buffer. They provide true data.

The 3-state control gate is a 2-input AND gate with active-low inputs so that, if either output-enable ($\overline{OE1}$ or $\overline{OE2}$) input is high, all nine affected outputs are in the high-impedance state.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54ABT16825 ... WD PACKAGE
SN74ABT16825 ... DL PACKAGE
(TOP VIEW)



ORDERING INFORMATION

| T_A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|--|-----------|---------------|-----------------------|------------------|
| -40°C to 85°C | SSOP – DL | Tube | SN74ABT16825DL | ABT16825 |
| | | Tape and reel | SN74ABT16825DLR | |
| -55°C to 125°C | CFP–WD | Tube | SNJ54ABT16825WD | SNJ54ABT16825WD |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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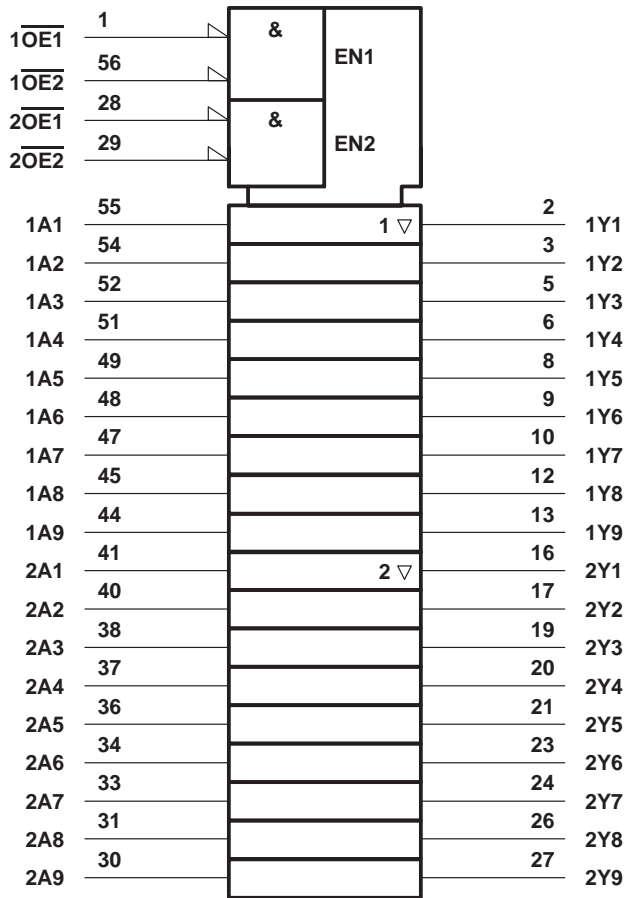
SN54ABT16825, SN74ABT16825
18-BIT BUFFERS/DRIVERS
WITH 3-STATE OUTPUTS

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FUNCTION TABLE
(each 9-bit section)

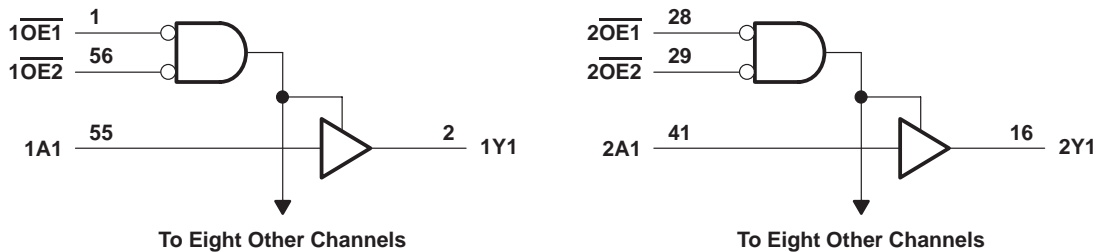
| INPUTS | | | OUTPUT Y |
|--------|-----|---|-------------|
| OE1 | OE2 | A | |
| L | L | L | L |
| L | L | H | H |
| H | X | X | Z |
| X | H | X | Z |

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



SN54ABT16825, SN74ABT16825 18-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| | |
|---|-----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, V_O | –0.5 V to 5.5 V |
| Current into any output in the low state, I_O : SN54ABT16825 | 96 mA |
| SN74ABT16825 | 128 mA |
| Input clamp current, I_{IK} ($V_I < 0$) | –18 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | –50 mA |
| Package thermal impedance, θ_{JA} (see Note 2) | 56°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

| | | | SN54ABT16825 | | SN74ABT16825 | | UNIT |
|---------------------|------------------------------------|--------------|--------------|-----------------|--------------|-----------------|------|
| | | | MIN | MAX | MIN | MAX | |
| V _{CC} | Supply voltage | | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V _{IH} | High-level input voltage | | 2 | | 2 | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | 0.8 | V |
| V _I | Input voltage | | 0 | V _{CC} | 0 | V _{CC} | V |
| I _{OH} | High-level output current | | | −24 | | −32 | mA |
| I _{OL} | Low-level output current | | | 48 | | 64 | mA |
| Δt/Δv | Input transition rise or fall rate | Control pins | 4 | | 4 | | ns/V |
| | | Data pins | 10 | | 10 | | |
| Δt/ΔV _{CC} | Power-up ramp rate | | 200 | | 200 | | μs/V |
| T _A | Operating free-air temperature | | −55 | 125 | −40 | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | $T_A = 25^\circ\text{C}$ | | | SN54ABT16825 | | SN74ABT16825 | | UNIT |
|-------------------|---|--------------------------|------|-----------|--------------|----------|--------------|-----------|---------------|
| | | MIN | TYP† | MAX | MIN | MAX | MIN | MAX | |
| V_{IK} | $V_{CC} = 4.5\text{ V}$, $I_I = -18\text{ mA}$ | | | -1.2 | | -1.2 | | -1.2 | V |
| V_{OH} | $V_{CC} = 4.5\text{ V}$, $I_{OH} = -3\text{ mA}$ | 2.5 | | | 2.5 | | 2.5 | | V |
| | $V_{CC} = 5\text{ V}$, $I_{OH} = -3\text{ mA}$ | 3 | | | 3 | | 3 | | |
| | $V_{CC} = 4.5\text{ V}$ | $I_{OH} = -24\text{ mA}$ | 2 | | 2 | | | | |
| | | $I_{OH} = -32\text{ mA}$ | 2* | | | | 2 | | |
| V_{OL} | $V_{CC} = 4.5\text{ V}$ | $I_{OL} = 48\text{ mA}$ | | 0.55 | 0.55 | | | | V |
| | | $I_{OL} = 64\text{ mA}$ | | 0.55* | | | 0.55 | | |
| V_{hys} | | | 100 | | | | | | mV |
| I_I | $V_{CC} = 0\text{ to }5.5\text{ V}$, $V_I = V_{CC}\text{ or GND}$ | | | ± 1 | | ± 1 | | ± 1 | μA |
| I_{OZPU} | $V_{CC} = 0\text{ to }2.1\text{ V}$, $V_O = 0.5\text{ V to }2.7\text{ V}$, $\overline{OE} = X$ | | | ± 50 | | ± 50 | | ± 50 | μA |
| I_{OZPD} | $V_{CC} = 2.1\text{ V to }0$, $V_O = 0.5\text{ V to }2.7\text{ V}$, $\overline{OE} = X$ | | | ± 50 | | ± 50 | | ± 50 | μA |
| I_{OZH} | $V_{CC} = 2.1\text{ V to }5.5\text{ V}$, $V_O = 2.7\text{ V}$, $\overline{OE} \geq 2\text{ V}$ | | | 10 | | 10 | | 10 | μA |
| I_{OZL} | $V_{CC} = 2.1\text{ V to }5.5\text{ V}$, $V_O = 0.5\text{ V}$, $\overline{OE} \geq 2\text{ V}$ | | | -10 | | -10 | | -10 | μA |
| I_{off} | $V_{CC} = 0$, $V_I\text{ or }V_O \leq 4.5\text{ V}$ | | | ± 100 | | | | ± 100 | μA |
| I_{CEX} | Outputs high $V_{CC} = 5.5\text{ V}$, $V_O = 5.5\text{ V}$ | | | 50 | | 50 | | 50 | μA |
| $I_{O\ddagger}$ | $V_{CC} = 5.5\text{ V}$, $V_O = 2.5\text{ V}$ | -50 | -100 | -180 | -50 | -180 | -50 | -180 | mA |
| I_{CC} | Outputs high | | | 2 | | 2 | | 2 | mA |
| | Outputs low | | | 32 | | 32 | | 32 | |
| | Outputs disabled | | | 2 | | 2 | | 2 | |
| $\Delta I_{CC}\S$ | $V_{CC} = 5.5\text{ V}$, One input at 3.4 V, Other inputs at $V_{CC}\text{ or GND}$ | | | 1.5 | | 1.5 | | 1.5 | mA |
| C_i | $V_I = 2.5\text{ V or }0.5\text{ V}$ | | | 3 | | | | | pF |
| C_o | $V_O = 2.5\text{ V or }0.5\text{ V}$ | | | 7.5 | | | | | pF |

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at $V_{CC} = 5\text{ V}$.

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

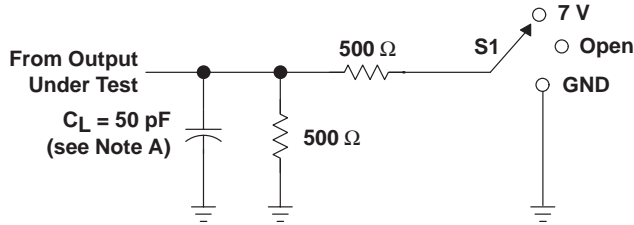
§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than $V_{CC}\text{ or GND}$.**switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)**

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ | | | SN54ABT16825 | | SN74ABT16825 | | UNIT |
|-----------|-----------------|-------------|---|-----|-----|--------------|-----|--------------|-----|------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t_{PLH} | A | Y | 1 | 1.9 | 3.6 | 1 | 4.1 | 1 | 3.9 | ns |
| t_{PHL} | | | 1 | 2.1 | 3.9 | 1 | 4.7 | 1 | 4.4 | |
| t_{PZH} | \overline{OE} | Y | 1 | 2.8 | 5.5 | 1 | 6.4 | 1 | 6.1 | ns |
| t_{PZL} | | | 1 | 2.8 | 5.4 | 1 | 6.3 | 1 | 6 | |
| t_{PHZ} | \overline{OE} | Y | 2.4 | 4.5 | 6.8 | 2.4 | 7.1 | 2.4 | 6.9 | ns |
| t_{PLZ} | | | 1.6 | 3.7 | 6.2 | 1.6 | 7.6 | 1.6 | 6.6 | |

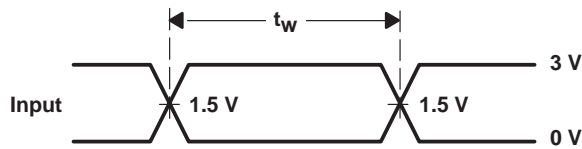
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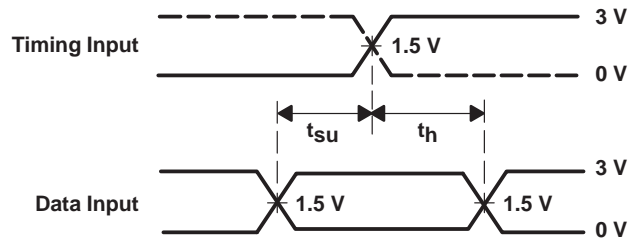
PARAMETER MEASUREMENT INFORMATION



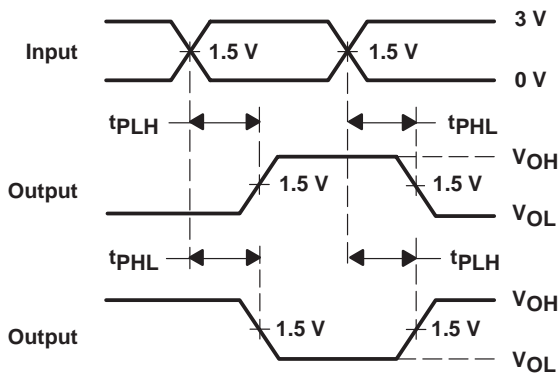
LOAD CIRCUIT



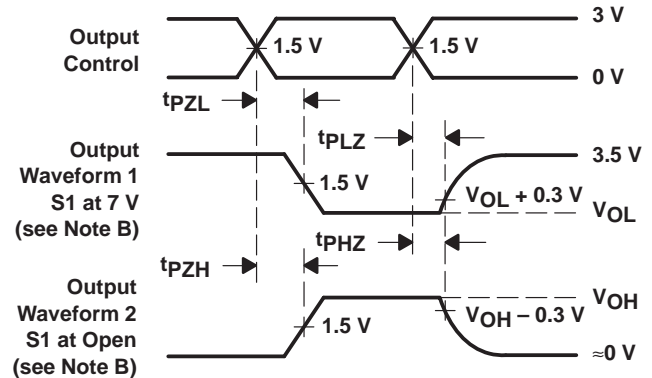
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|---------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| SN74ABT16825DL | Active | Production | SSOP (DL) 56 | 20 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16825 |
| SN74ABT16825DL.B | Active | Production | SSOP (DL) 56 | 20 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16825 |
| SN74ABT16825DLR | Active | Production | SSOP (DL) 56 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16825 |
| SN74ABT16825DLR.B | Active | Production | SSOP (DL) 56 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | ABT16825 |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ABT16825DLR | SSOP | DL | 56 | 1000 | 330.0 | 32.4 | 11.35 | 18.67 | 3.1 | 16.0 | 32.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT16825DLR | SSOP | DL | 56 | 1000 | 356.0 | 356.0 | 53.0 |

TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ABT16825DL | DL | SSOP | 56 | 20 | 473.7 | 14.24 | 5110 | 7.87 |
| SN74ABT16825DL.B | DL | SSOP | 56 | 20 | 473.7 | 14.24 | 5110 | 7.87 |

DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MO-118

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